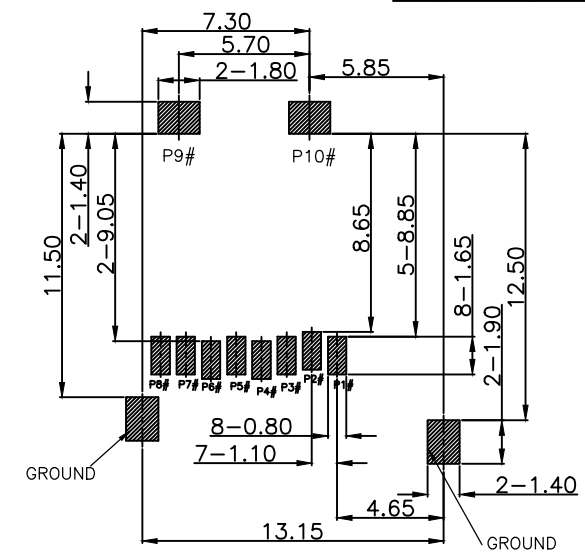
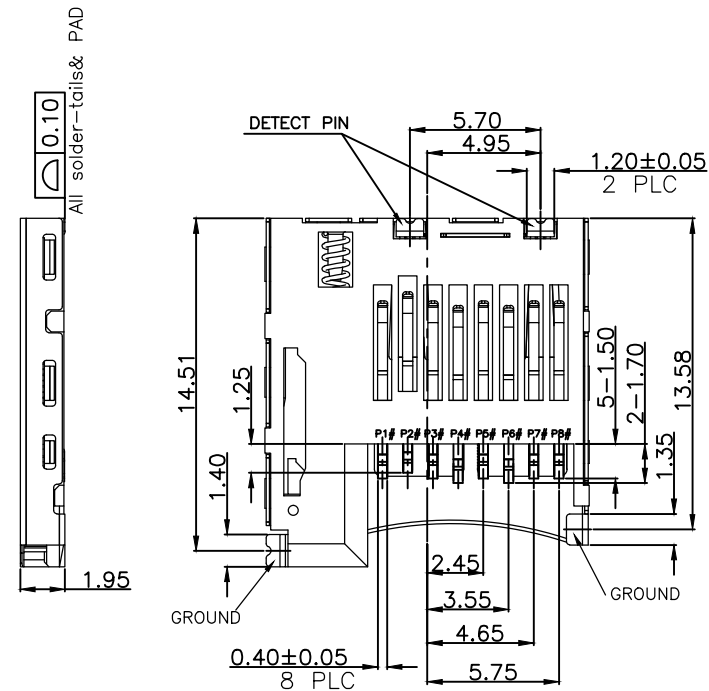
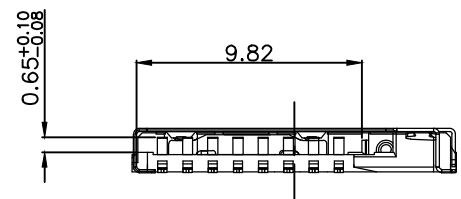
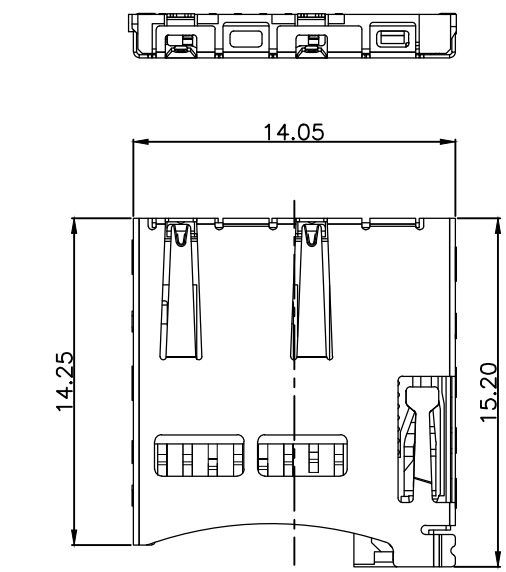


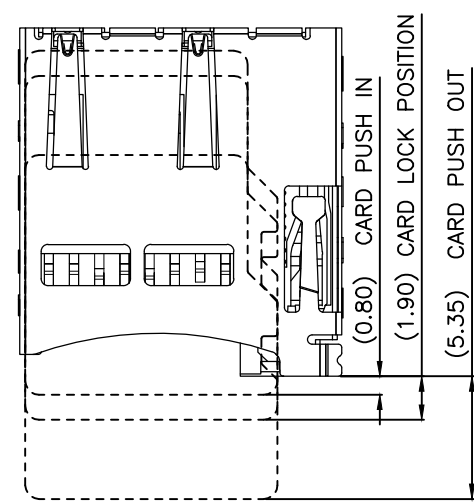
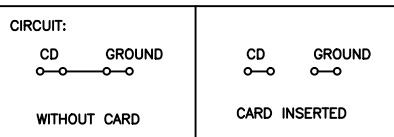
REV.	ECN.NO.	MODIFY.CONTENT	DATE
A0		NEW	2017/09/28




RECOMMENDED PCB LAYOUT
(ALL TOLERANCE ARE ±0.05)

- NOTES:
1) MATERIAL:
HOUSING : LCP S475, COLOR:BLACK UL 94-V0
CONTACT : COPPER ALLOY,T=0.15mm
SHELL : STANLESS STEEL,T=0.15mm
2) FINISH :
CONTACT:GOLD FLASH PLATED ON CONTACT AREA;
GOLD FLASH PLATED ON SOLDER TAILS,
SHELL: GOLD FLASH PLATED ON SOLDER TAILS

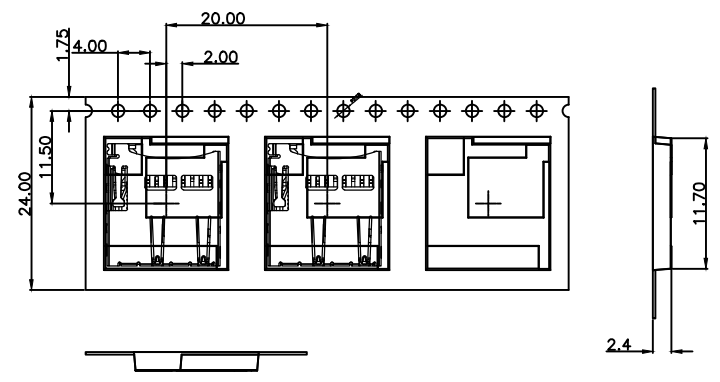
Pin No.		MICRO SD
PIN1	DAT2	1P
PIN2	CD/DAT3	2P
PIN3	CMD	3P
PIN4	VDD	4P
PIN5	CLK	5P
PIN6	VSS	6P
PIN7	DAT0	7P
PIN8	DAT1	8P
PIN9	CARD DETECT	
PIN10		



GENERAL TOLERANCE				DWG NO.		APPD:		Scale	1:1
X.±0.45	x.°±5°		Title	MICRO SD PUSH CONN 内焊 常闭型	CHKD:		UNIT	mm	
.X±0.35	.x°±2°				DR:				
.XX±0.25	.xx°±1°		Part NO.	5001B-TF190-007	Date	2017/9/28			
.XXX±0.15		.xxx°±0.5°		东莞市文章济美电子有限公司					
SHEET	1/1								

REV.	ECN.NO.	MODIFY.CONTENT	DATE
A0		NEW	2017/09/28
A1		更新料号	2018/12/21

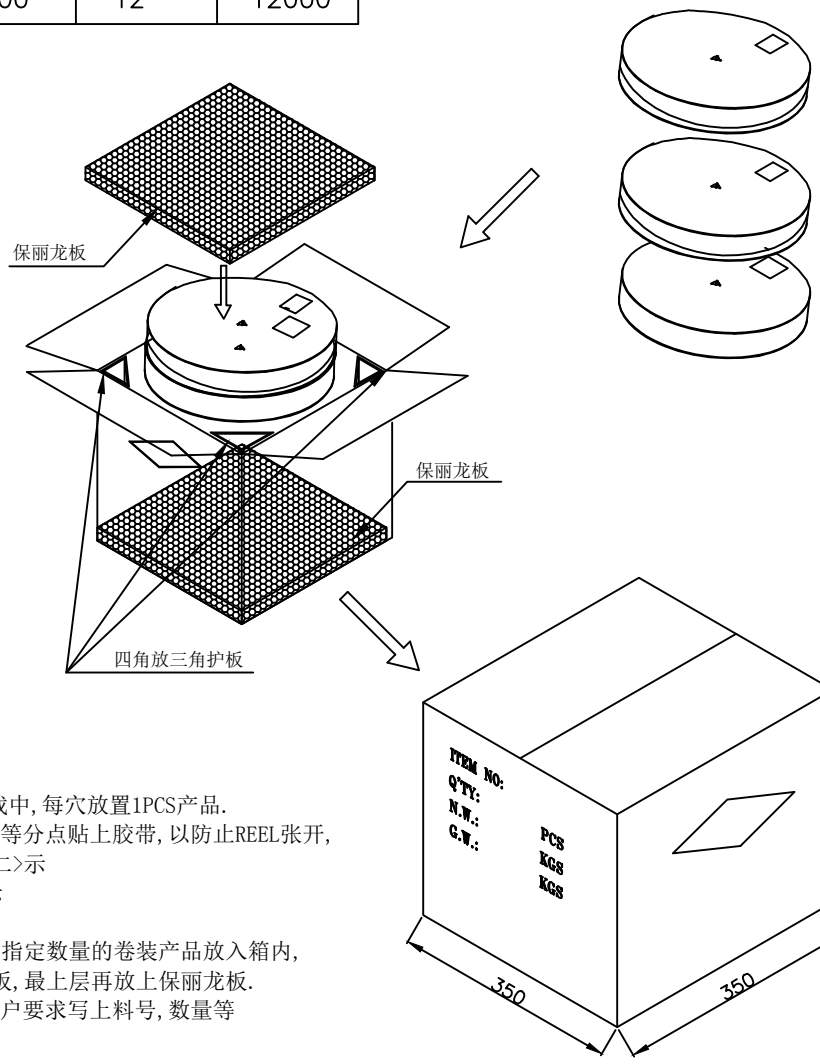
<图一>



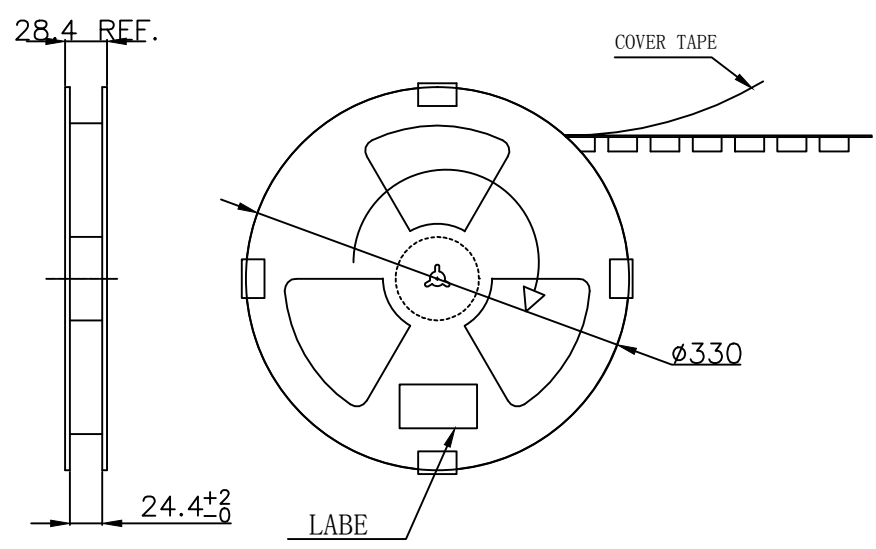
<TABLE 1> PACKAGING QUANTITY

QTY/REEL	REEL/CARTON	QTY/CARTON
1000	12	12000

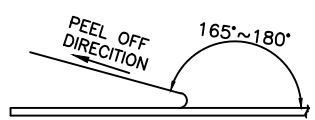
<图三>



<图二>



COVER TAPE PEELING FORCE:50gf~150gf



NOTE:

- 1.依<图一>示放置产品于下载中, 每穴放置1PCS产品.
- 2.包装机包好后, 在REEL的个等分点贴上胶带, 以防止REEL张开, 每REEL贴1PCS标签, 如<图二>示
- 3.包装数量见如<TABLE 1>示
- 4.包装成箱见如<图三>示
箱底放保丽龙板, 再依次将指定数量的卷装产品放入箱内, 四角分别放入四个三角护板, 最上层再放上保丽龙板.
- 5.封箱, 在封好的纸箱上按客户要求写上料号, 数量等

GENERAL TOLERANCE		图 号	设计	比例	1:1
X.±0.45	x.±5°	品 名	PUSH T-FLASH CONN	审 核	单 位
X.±0.35	x.±2°		内焊 常闭型一包装图	核 准	mm
.XX±0.25	.xx'±1°	料 号	5001B-TF190-007	日 期	2017/9/28
.XXX±0.15	.xxx'±0.5°				
页号	1/1				东莞市文章济美电子有限公司